

CMOS Digital Integrated Circuits Silicon Monolithic

# 74LCX05FT

#### 1. Functional Description

Low-Voltage Hex Inverter with 5-V Tolerant Inputs and Outputs (Open Drain)

#### 2. General

The 74LCX05FT is a high-performance CMOS inverter. Designed for use in 3.3 V systems and 5 V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

Pin configuration and function are the same as the 74LCX04FT, but the 74LCX05FT has high performance MOS N-channel transistor. (open-drain outputs)

The device is designed for low-voltage (3.3 V)  $V_{CC}$  applications, but it could be used to interface to 5 V supply\* environment for inputs.

All inputs are equipped with protection circuits against static discharge.

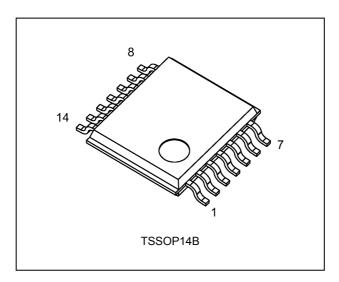
 $*I_{OUT}$  absolute maximum rating must be observed.

#### 3. Features

- (1) AEC-Q100 (Rev. H) (Note 1)
- (2) Wide operating temperature range:  $T_{opr} = -40$  to 125 °C
- (3) Low-voltage operation:  $V_{CC} = 1.65$  to 5.5 V
- (4) High-speed operation:  $t_{pZ} = 5.5 \text{ ns (max)} (V_{CC} = 3.3 \pm 0.3 \text{ V})$
- (5) Output current:  $I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- (6) Open-drain outputs
- (7) Power-down protection provided on all inputs and outputs
- (8) Pin and function compatible with the 74 series (74LVC/ALVC etc.) 05 type

Note 1: This device is compliant with the reliability requirements of AEC-Q100. For details, contact your Toshiba sales representative.

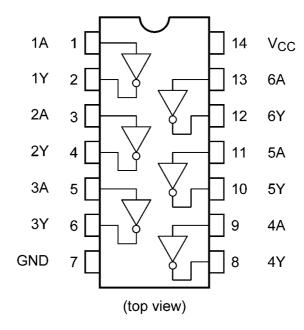
#### 4. Packaging



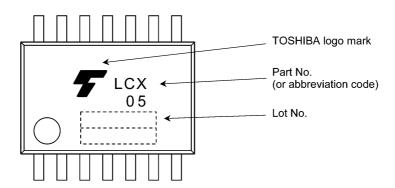
Start of commercial production



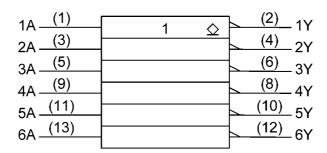
## 5. Pin Assignment



# 6. Marking



# 7. IEC Logic Symbol



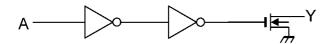
#### 8. Truth Table

Inputs A	Outputs Y
L	Z
Н	L

Z: High impedance



#### 9. System Diagram(per gate)



#### 10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 6.5	V
Input voltage	V <sub>IN</sub>		-0.5 to 6.5	V
Output voltage	V <sub>OUT</sub>	(Note 1)	-0.5 to 6.5	V
Input diode current	I <sub>IK</sub>		-50	mA
Output diode current	I <sub>OK</sub>	(Note 2)	-50	mA
Output current	I <sub>OUT</sub>		50	mA
Power dissipation	P <sub>D</sub>	(Note 3)	180	mW
V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>		±100	mA
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Output in OFF state. I<sub>OUT</sub> absolute maximum rating must be observed. (Output in low state)

Note 2: VOUT < GND

Note 3: 180 mW in the range of  $T_a$  = -40 to 85 °C. From  $T_a$  = 85 to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

### 11. Operating Ranges (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	$V_{CC}$		1.65 to 5.5	V
		(Note 1)	1.5 to 5.5	
Input voltage	$V_{IN}$		0 to 5.5	V
Output voltage	V <sub>OUT</sub>		0 to 5.5	V
Output current	I <sub>OL</sub>	(Note 2)	32	mA
		(Note 3)	24	
		(Note 4)	12	
Operating temperature	T <sub>opr</sub>		-40 to 125	°C
Input rise and fall times	dt/dv	(Note 5)	0 to 10	ns/V

Note: The operating ranges are required to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

Note 1: Data retention only

Note 2:  $V_{CC}$  = 4.5 to 5.5 V

Note 3:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 4:  $V_{CC}$  = 2.7 to 3.0 V

Note 5:  $V_{CC}$  = 1.65 to 5.5 V



#### 12. Electrical Characteristics

# 12.1. DC Characteristics (Unless otherwise specified, $T_a$ = -40 to 85 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>			1.65 to 2.3	$V_{CC} \times 0.9$	_	V
				2.3 to 2.7	1.7	_	
				2.7 to 3.6	2.0	_	
				4.5 to 5.5	$V_{\text{CC}} \times 0.7$	_	
Low-level input voltage	V <sub>IL</sub>			1.65 to 2.3	_	V <sub>CC</sub> × 0.1	V
				2.3 to 2.7	_	0.7	
				2.7 to 3.6		0.8	
				4.5 to 5.5		$V_{CC} \times 0.3$	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH}$	I <sub>OL</sub> = 100 μA	1.65 to 5.5	ı	0.2	V
			$I_{OL}$ = 4 mA	1.65		0.45	
			$I_{OL}$ = 8 mA	2.3	ı	0.7	
			I <sub>OL</sub> = 12 mA	2.7		0.4	
			I <sub>OL</sub> = 16 mA	3.0	ı	0.4	
			I <sub>OL</sub> = 24 mA	3.0	ı	0.55	
			I <sub>OL</sub> = 32 mA	4.5		0.55	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		1.65 to 5.5		±5.0	μΑ
Output OFF-state leakage current	I <sub>OZ</sub>	$V_{IN} = V_{IH}$ $V_{OUT} = 0 \text{ to } 5.5 \text{ V}$		1.65 to 5.5	1	±5.0	μА
Power-OFF leakage current	I <sub>OFF</sub>	$V_{IN}/V_{OUT} = 5.5 V$		0		10.0	μΑ
Quiescent supply current	Icc	$V_{IN} = V_{CC}$ or GND		1.65 to 5.5		10.0	μΑ
Quiescent supply current	$\Delta I_{CC}$	$V_{IH} = V_{CC} - 0.6 V$		2.7 to 3.6		500	μΑ
		(per 1 input)		4.5 to 5.5	_	1.0	mA

# 12.2. DC Characteristics (Unless otherwise specified, $T_a$ = -40 to 125 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		1.65 to 2.3	$V_{CC} \times 0.9$	_	V
				2.3 to 2.7	1.7	_	
				2.7 to 3.6	2.0		
				4.5 to 5.5	$V_{CC} \times 0.7$		
Low-level input voltage	V <sub>IL</sub>	_		1.65 to 2.3	ı	$V_{CC} \times 0.1$	٧
				2.3 to 2.7	ı	0.7	
				2.7 to 3.6	l	0.8	
				4.5 to 5.5		$V_{CC} \times 0.3$	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH}$	I <sub>OL</sub> = 100 μA	1.65 to 5.5		0.2	V
			$I_{OL}$ = 4 mA	1.65	ı	0.6	
			$I_{OL}$ = 8 mA	2.3	ı	0.85	
			I <sub>OL</sub> = 12 mA	2.7		0.6	
			I <sub>OL</sub> = 16 mA	3.0		0.6	
			I <sub>OL</sub> = 24 mA	3.0	-	0.8	
			I <sub>OL</sub> = 32 mA	4.5		0.8	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V		1.65 to 5.5		±20.0	μΑ
Output OFF-state leakage current	I <sub>OZ</sub>	$V_{IN} = V_{IH}$ $V_{OUT} = 0 \text{ to } 5.5 \text{ V}$		1.65 to 5.5	_	±20.0	μА
Power-OFF leakage current	I <sub>OFF</sub>	$V_{IN}/V_{OUT} = 5.5 V$		0	_	40.0	μΑ
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		1.65 to 5.5	_	40.0	μΑ
Quiescent supply current	Δl <sub>CC</sub>	$V_{IH} = V_{CC} - 0.6 \text{ V}$		2.7 to 3.6		5.0	mA
		(per 1 input)		4.5 to 5.5	_	5.0	mA



# 12.3. AC Characteristics (Unless otherwise specified, T<sub>a</sub> = -40 to 85 °C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Output enable time	t <sub>PZL</sub>		See 12.7. AC Test Circuit,	$1.8 \pm 0.15$	1.5	26.0	ns
			Table 12.7.1, Fig. 12.8.1, Table 12.8.1	$2.5 \pm 0.2$	1.2	13.0	
			14DIE 12.0.1	2.7	1.0	6.0	
				$3.3 \pm 0.3$	0.8	5.0	
				$5.0\pm0.5$	0.5	4.0	
Output disable time	t <sub>PLZ</sub>		See 12.7. AC Test Circuit,	1.8 ± 0.15	1.5	26.0	ns
			Table 12.7.1, Fig. 12.8.1, Table 12.8.1		1.2	13.0	
					1.0	6.0	
				$3.3 \pm 0.3$	0.8	5.0	
				5.0 ± 0.5	0.5	4.0	
Output skew	t <sub>osZL</sub>	(Note 1)	_	2.7	_	_	ns
				$3.3\pm0.3$	_	1.0	

Note 1: Parameter guaranteed by design.  $(t_{osZL} = |t_{PZL}m-t_{PZL}n|)$ 

# 12.4. AC Characteristics (Unless otherwise specified, T<sub>a</sub> = -40 to 125 °C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Output enable time	t <sub>PZL</sub>		See 12.7. AC Test Circuit,	1.8 ± 0.15	1.5	29.0	ns
			Table 12.7.1, Fig. 12.8.1, Table 12.8.1	2.5 ± 0.2	1.2	14.5	
			1 able 12.0.1	2.7	1.0	7.0	
				$3.3 \pm 0.3$	0.8	5.5	
				5.0 ± 0.5	0.5	4.5	
Output disable time	t <sub>PLZ</sub>		See 12.7. AC Test Circuit,		1.5	29.0	ns
			Table 12.7.1, Fig. 12.8.1, Table 12.8.1	$2.5 \pm 0.2$	1.2	14.5	
			Table 12.0.1		1.0	7.0	
				$3.3 \pm 0.3$	0.8	5.5	
				5.0 ± 0.5	0.5	4.5	
Output skew	t <sub>osZL</sub>	(Note 1)	_	2.7	_		ns
				$3.3 \pm 0.3$	_	1.0	

Note 1: Parameter guaranteed by design.  $(t_{osZL} = |t_{PZL}m-t_{PZL}n|)$ 

# 12.5. Dynamic Switching Characteristics (Unless otherwise specified, $T_a$ = 25 °C, Input: $t_r$ = $t_f$ = 2.5 ns, $C_L$ = 50 pF, $R_L$ = 500 $\Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V

# 12.6. Capacitive Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>			3.3	7	pF
Output capacitance	C <sub>OUT</sub>			3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	(Note 1)	f <sub>IN</sub> =10 MHz	3.3	5	pF

Note 1:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.  $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}/6 \text{ (per 1 gate)}$ 



#### 12.7. AC Test Circuit

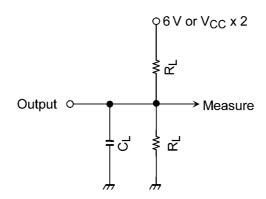


Table 12.7.1 Parameter for AC Test Circuit

Parameter	Switch	Test Condition
t <sub>PLZ</sub> , t <sub>PZL</sub>	6.0 V	$V_{CC}$ = 3.3 $\pm$ 0.3 $V$
		V <sub>CC</sub> = 2.7 V
	V <sub>CC</sub> × 2	$V_{CC}$ = 5.0 $\pm$ 0.5 $V$
		$V_{CC}$ = 2.5 $\pm$ 0.2 $V$
		V <sub>CC</sub> = 1.8 ± 0.15 V

#### 12.8. AC Waveform

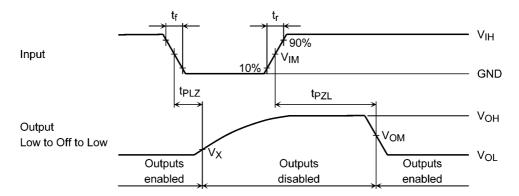


Fig. 12.8.1 tpLZ,tpZL

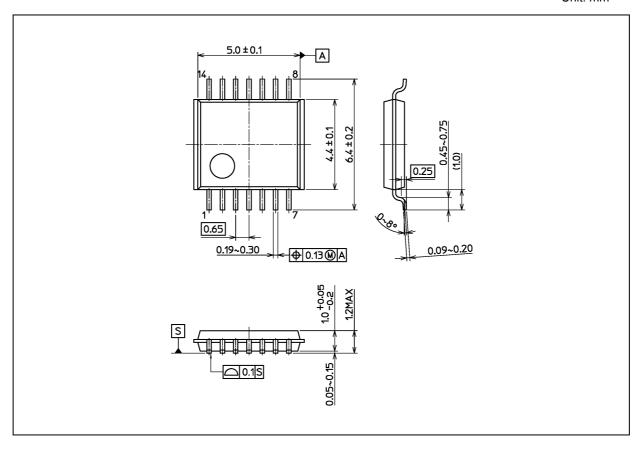
Table 12.8.1 AC Waveform Symbols

	Symbol	$V_{CC}$ = 5.0 $\pm$ 0.5 $V$	$V_{CC} = 3.3 \pm 0.3 \text{ V}$ $V_{CC} = 2.7 \text{ V}$	$V_{CC}$ = 2.5 $\pm$ 0.2 V	$V_{CC}$ = 1.8 $\pm$ 0.15 V
Input	V <sub>IH</sub>	V <sub>CC</sub>	2.7 V	V <sub>CC</sub>	V <sub>CC</sub>
	$V_{IM}$	V <sub>CC</sub> /2	1.5 V	V <sub>CC</sub> /2	V <sub>CC</sub> /2
	t <sub>r</sub> , t <sub>f</sub>	2.5 ns	2.5 ns	2.0 ns	2.0 ns
Output	V <sub>OM</sub>	V <sub>CC</sub> /2	1.5 V	V <sub>OH</sub> /2	V <sub>OH</sub> /2
	V <sub>X</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.15 V	V <sub>OL</sub> + 0.15 V
Load	C <sub>L</sub>	50 pF	50 pF	30 pF	30 pF
	$R_L$	500 Ω	500 Ω	500 Ω	1 kΩ



# **Package Dimensions**

Unit: mm



Weight: 0.054 g (typ.)

Package Name(s)
Nickname: TSSOP14B



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